

Rilsan® BMN TL

Polyamide 11

Arkema

Message:

Polyamide (PA11), rigid, heat stabilized molding compound.
Please contact Atofina for additional information.

General Information	
Additive	Heat Stabilizer
Features	Heat Stabilized
	Renewable Resource Content
Uses	Automotive Applications
Appearance	Black
Forms	Pellets
Processing Method	Injection Molding

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Recommended distributors for this material

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WECHAT